

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10533147
<b>Filing Date:</b>	27-Apr-2005
<b>Title of Invention:</b>	METHOD FOR PRODUCING SILICON WAFER
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<b>Filer:</b>	Gerald T. Shekleton/Mawish Elahi
<b>Attorney Docket Number:</b>	94198

Filed as Large Entity

### **U.S. National Stage under 35 USC 371 Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Utility Appl issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Extension-of-Time:</b>				
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>1740</b>